

200mW, 75V Switching Diode

FEATURES

- Low power loss, high efficiency
- Fast switching speed
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21
- Moisture sensitivity level: level 1, per J-STD-020

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter

MECHANICAL DATA

• Case: SOD-323

• Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

Meet JESD 201 class 1A whisker test

• Polarity: Indicated by cathode band

• Weight: 4.50mg (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	150	mA	
V_{R}	75	V	
V _F at I _F = 150mA	1.25	V	
T _J	150	°C	
Package	SOD-323		
Configuration	Single die		







SOD-323



PARAMETER	SYMBOL	1N4148WS-G	UNIT
Marking code on the device		T4	
Power dissipation	P _D	200	mW
Repetitive peak reverse voltage	V _{RM}	100	V
Reverse voltage	V _R	75	V
Forward current	I _F	150	mA
Non-repettive peak forward current	I _{FM}	300	mA
Peak forward surge current @ t = 1µs	I _{FSM}	2	А
Junction temperature range	T _J	-55 to +150	°C
Storage temperature range	T _{STG}	-55 to +150	°C

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ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	MIN	MAX	UNIT
Forward voltage ⁽¹⁾	I _F = 1mA, T _J = 25°C	V _F	-	0.715	V
	$I_F = 10 \text{mA}, T_J = 25 ^{\circ}\text{C}$		-	0.885	V
	$I_F = 50 \text{mA}, T_J = 25^{\circ}\text{C}$		-	1.000	V
	I _F = 150mA, T _J = 25°C		-	1.250	V
Reverse current @ rated V _R ⁽²⁾	$V_R = 20V, T_J = 25^{\circ}C$		-	25	nA
	$V_R = 75V, T_J = 25^{\circ}C$	- I _R	-	1	μΑ
Junction capacitance	$1MHz, V_R = 0V$	CJ	-	2	pF
Reverse recovery time	$I_F = I_R = 10\text{mA},$ $R_L = 100\Omega, I_{RR} = 1\text{mA}$	t _{rr}	-	4	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
1N4148WS-G RVG	SOD-323	3,000 / 7" Tape & Reel



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Typical Reverse Characteristics

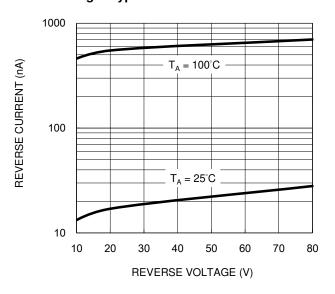


Fig.2 Typical Forward Characteristics

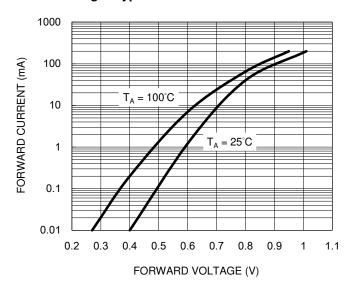


Fig.3 Power Derating Curve

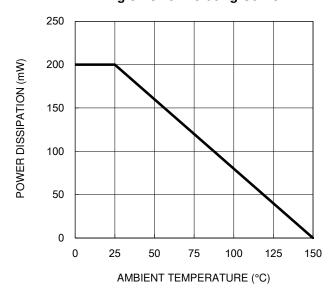
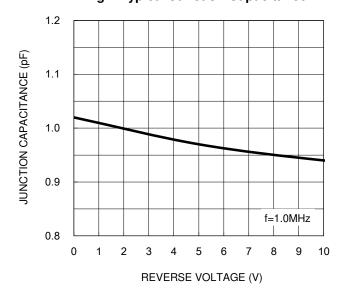
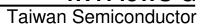


Fig.4 Typical Junction Capacitance

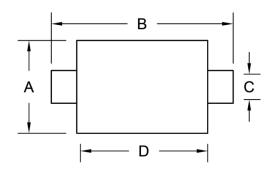


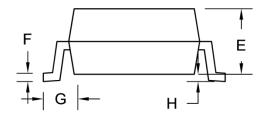




PACKAGE OUTLINE DIMENSION

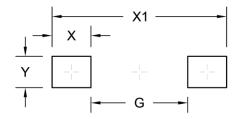
SOD-323





DIM.	Unit (mm)		Unit (inch)	
Dilvi.	Min.	Max.	Min.	Max.	
Α	1.150	1.400	0.045	0.055	
В	2.300	2.700	0.091	0.106	
С	0.250	0.450	0.010	0.018	
D	1.600	1.800	0.063	0.071	
E	0.800	1.000	0.031	0.039	
F	0.050	0.177	0.002	0.007	
G	0.475	(Ref.)	0.019	(Ref.)	
Н	-	0.100	-	0.004	

SUGGEST PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
G	1.52	0.060
X	0.61	0.024
X1	2.74	0.108
Y	0.49	0.019



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